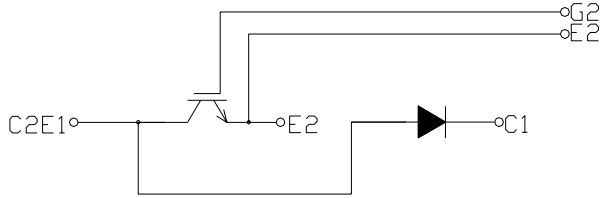
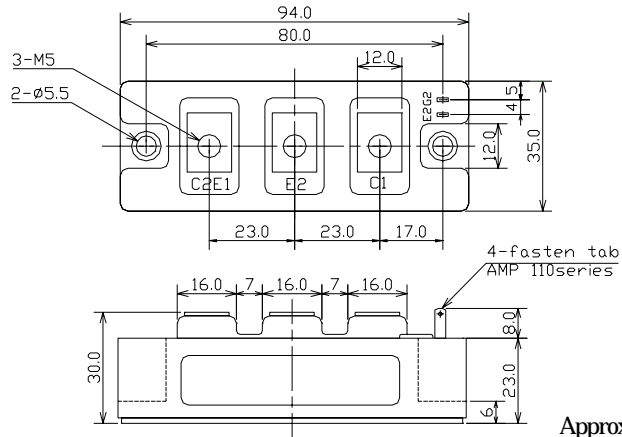


CIRCUIT



OUTLINE DRAWING



2-fasten- tab No 110

Dimension(mm)

Approximate Weight : 220g

MAXMUM RATINGS (Tc=25°C)

Item		Symbol	PRHMB100A6	Unit
Collector-Emitter Voltage		V <sub>CES</sub>	600	V
Gate - Emitter Voltage		V <sub>GES</sub>	+/- 20	V
Collector Current	DC	I <sub>C</sub>	100	A
	1 ms	I <sub>C</sub>	200	
Collector Power Dissipation		P <sub>C</sub>	400	W
Junction Temperature Range		T <sub>j</sub>	-40 to +150	°C
Storage Temperature Range		T <sub>sg</sub>	-40 to +125	°C
Isolation Voltage (Terminal to Base AC, 1 min.)		V <sub>ISO</sub>	2500	V
Mounting Torque	Module Base to Heat sink	F <sub>TOR</sub>	2.04	N•m
	Bus Bar to Main Terminals			

ELECTRICAL CHARACTERISTICS (Tc=25°C)

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Collector-Emitter Cut-Off Current		I <sub>CES</sub>	V <sub>CE</sub> =600V, V <sub>GE</sub> =0V	-	-	1.0	mA
Gate-Emitter Leakage Current		I <sub>GES</sub>	V <sub>GE</sub> =+/- 20V, V <sub>CE</sub> =0V	-	-	1.0	µA
Collector-Emitter Saturation Voltage		V <sub>CE(sat)</sub>	I <sub>C</sub> =100A, V <sub>GE</sub> =15V	-	2.1	2.6	V
Gate-Emitter Threshold Voltage		V <sub>GE(th)</sub>	V <sub>CE</sub> =5V, I <sub>C</sub> =100mA	4.0	-	8.0	V
Input Capacitance		C <sub>ies</sub>	V <sub>CE</sub> =10V, V <sub>GE</sub> =0V, f=1MHz	-	10000	-	pF
Switching Time	Rise Time	t <sub>r</sub>	V <sub>CC</sub> = 300V	-	0.15	0.3	µs
	Turn-on Time	t <sub>on</sub>	R <sub>L</sub> = 3 ohm	-	0.25	0.4	
	Fall Time	t <sub>f</sub>	R <sub>G</sub> = 7.5 ohm	-	0.2	0.35	
	Turn-off Time	t <sub>off</sub>	V <sub>GE</sub> = +/- 15V	-	0.45	0.7	

FREE WHEELING DIODES RATINGS & CHARACTERISTICS (Tc=25°C)

Item		Symbol	Rated Value	Unit
Forward Current	DC	I <sub>F</sub>	100	A
	1 ms	I <sub>FM</sub>	200	

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Peak Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =100A, V <sub>GE</sub> =0V	-	1.9	2.4	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =100A, V <sub>GE</sub> =-10V, di/dt=100A/µs	-	0.15	0.25	µs

THERMAL CHARACTERISTICS

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Thermal Impedance	IGBT	R <sub>th(j-c)</sub>	Junction to Case	-	-	0.31	°C/W
	DIODE			-	-	0.65	

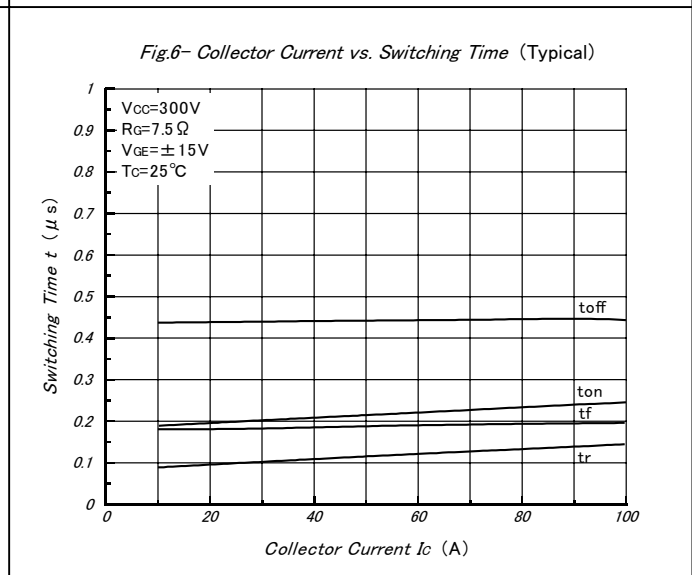
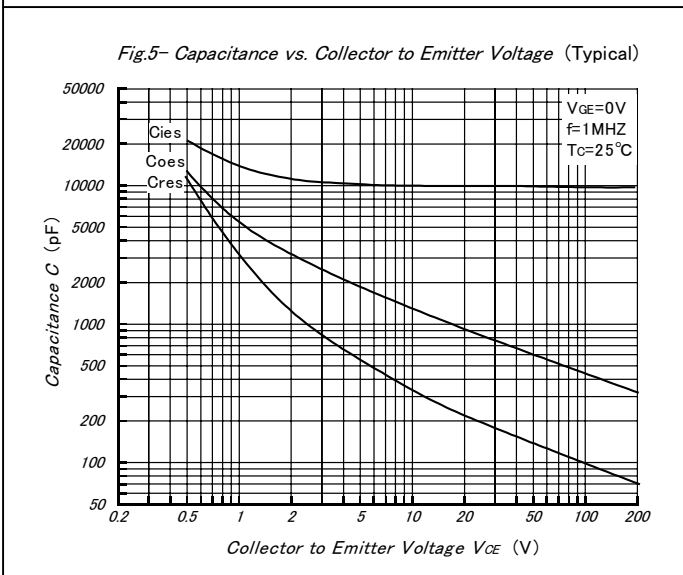
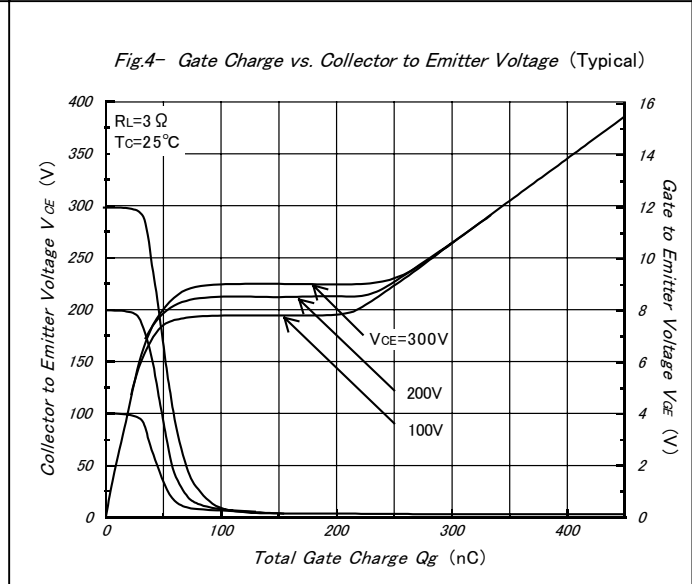
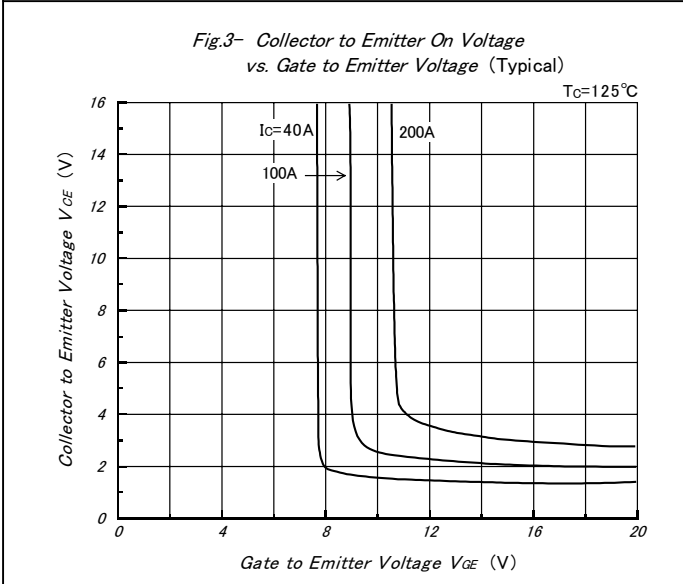
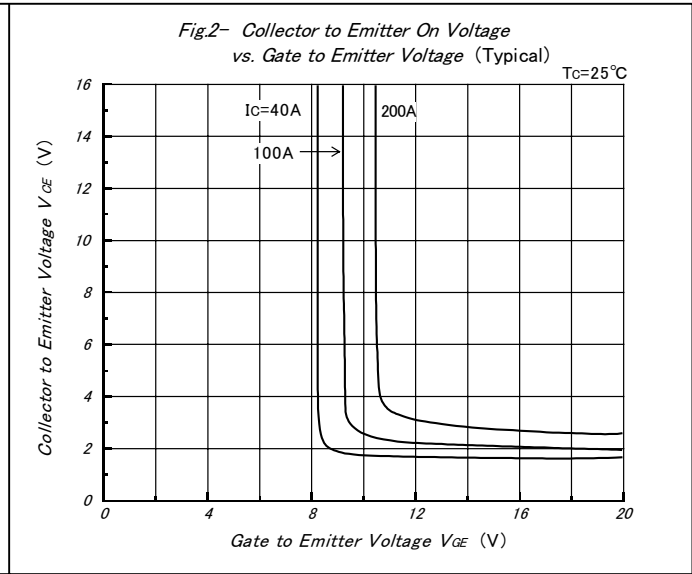
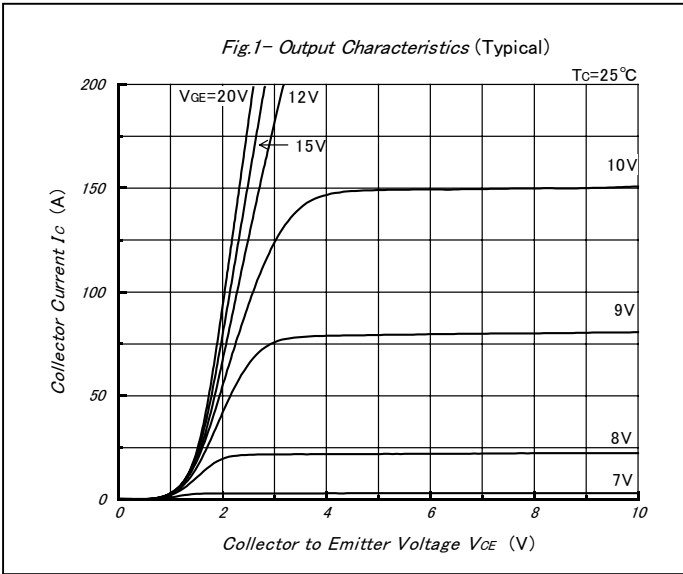


Fig.7- Series Gate Impedance vs. Switching Time (Typical)

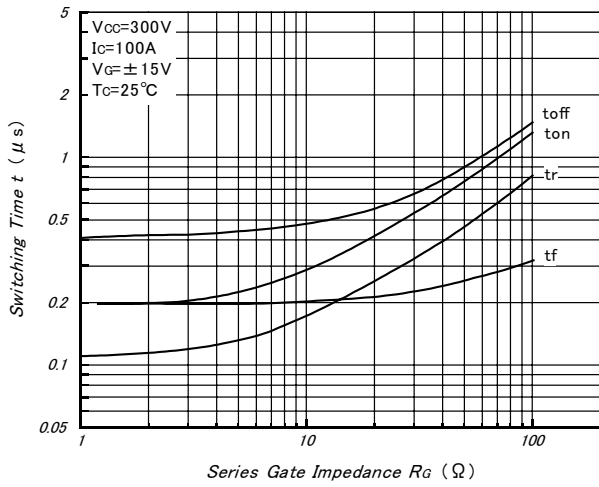


Fig.8- Forward Characteristics of Free Wheeling Diode (Typical)

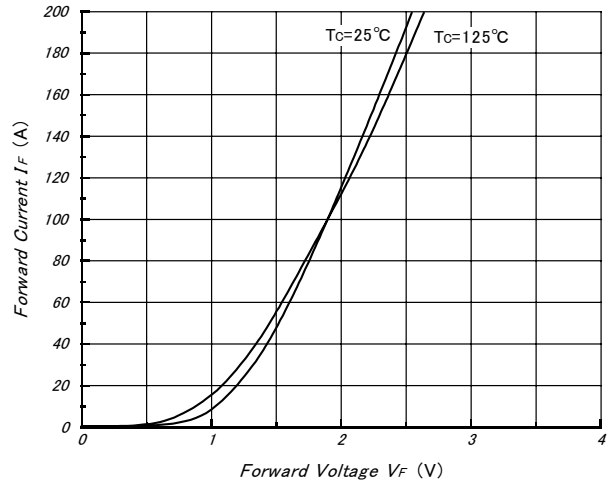


Fig.9- Reverse Recovery Characteristics (Typical)

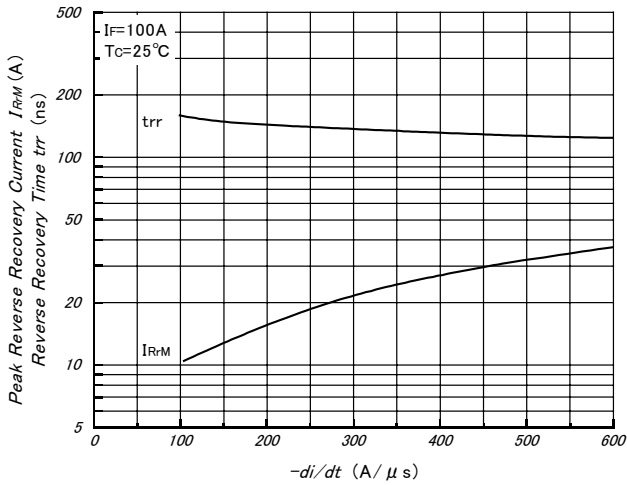


Fig.10- Reverse Bias Safe Operating Area (Typical)

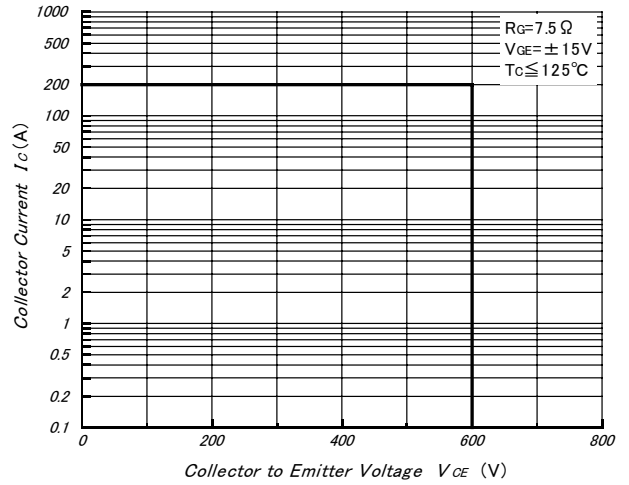


Fig.11- Transient Thermal Impedance

